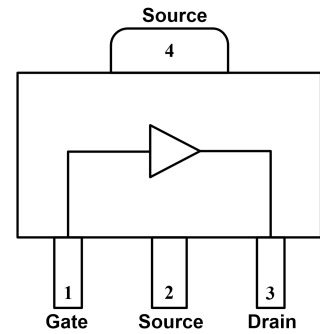


Description

Innotion's YP601238T is a 7-watt, unmatched gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities with frequency up to 7200MHz.

The transistor is supplied in a plastic SOT-89 package.



Package: SOT89-3

Mark: YP601238T

Typical Performance (T_c=25°C) of Demonstration Amplifier

Table1. 1.5~2.1GHz CW (Test in Innotion Fixture)

Driver: YP2233W (Bias: VCC= 5.0V, Vref=2.7V, ICQ=200mA)

GaN PA: YP601238T (Bias: VDD=28V, VGS=-2.6V, IDQ=100mA)

| Frequency (MHz) | Psat(dBm) | ICC(mA)@5V | IDS(mA)@28V |
|-----------------|-----------|------------|-------------|
| 1500 | 38.9 | 500 | 650 |
| 1600 | 38.7 | 510 | 640 |
| 1700 | 38.5 | 490 | 630 |
| 1800 | 38.5 | 490 | 610 |
| 1900 | 38.4 | 480 | 620 |
| 2000 | 38.4 | 490 | 610 |
| 2100 | 38.3 | 480 | 600 |

Table2. 3.3~3.8GHz CW (Test in Innotion Fixture)

Driver: YP352833 (Bias: VCC= 5.0V, Vref=2.7V, ICQ=150mA)

GaN PA: YP601238T (Bias: VDD=28V, VGS=-2.6V, IDQ=100mA)

| Frequency (MHz) | Psat(dBm) | ICC(mA)@5V | IDS(mA)@28V |
|-----------------|-----------|------------|-------------|
| 3300 | 39.4 | 410 | 620 |
| 3400 | 39.4 | 450 | 610 |
| 3500 | 39.5 | 480 | 590 |
| 3600 | 39.4 | 480 | 580 |
| 3700 | 39.4 | 470 | 570 |
| 3800 | 39.2 | 470 | 560 |

Table3. 5.1~5.9GHz CW (Test in Innotion Fixture)

Driver: YP553030 (Bias: VCC= 5.0V, PEN=2.7V, ICQ=170mA)

GaN PA: YP601238T (Bias: VDD=28V, VGS=-2.58V, IDQ=120mA)

| Frequency (MHz) | Psat(dBm) | ICC(mA)@5V | IDS(mA)@28V |
|-----------------|-----------|------------|-------------|
| 5100 | 39.1 | 880 | 600 |
| 5500 | 39 | 830 | 590 |
| 5900 | 39.1 | 850 | 580 |

Table4. 6.0~7.2GHz CW (Test in Innotion Fixture)

Driver: YP702530 (Bias: VCC= 5.0V, Vref=2.8V, ICQ=350mA)

GaN PA: YP601238T (Bias: VDD=28V, VGS=-2.58V, IDQ=120mA)

| Frequency (MHz) | Psat(dBm) | ICC(mA)@5V | IDS(mA)@28V |
|-----------------|-----------|------------|-------------|
| 6000 | 37.2 | 920 | 550 |
| 6300 | 37.3 | 950 | 560 |
| 6600 | 37.5 | 1030 | 590 |
| 6900 | 37.3 | 980 | 580 |
| 7200 | 37.2 | 950 | 570 |

Features

- High Efficiency and Linear Gain Operation
- Negative Gate Voltage and Bias Sequencing Required
- Excellent Thermal Stability and Excellent Ruggedness
- Metal Based Package Sealed with Ceramic-Epoxy Lid
- Gold Metallization System: Chip-Wire Bond-Package

Table3. Maximum Ratings

| Rating | Symbol | Value | Unit |
|---------------------------|------------------|-------------|------|
| Drain-Source Voltage | V _{DSS} | +160 | Vdc |
| Gate-Source Voltage | V _{GS} | -10 to +2 | Vdc |
| Operating Voltage | V _{DD} | +55 | Vdc |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |

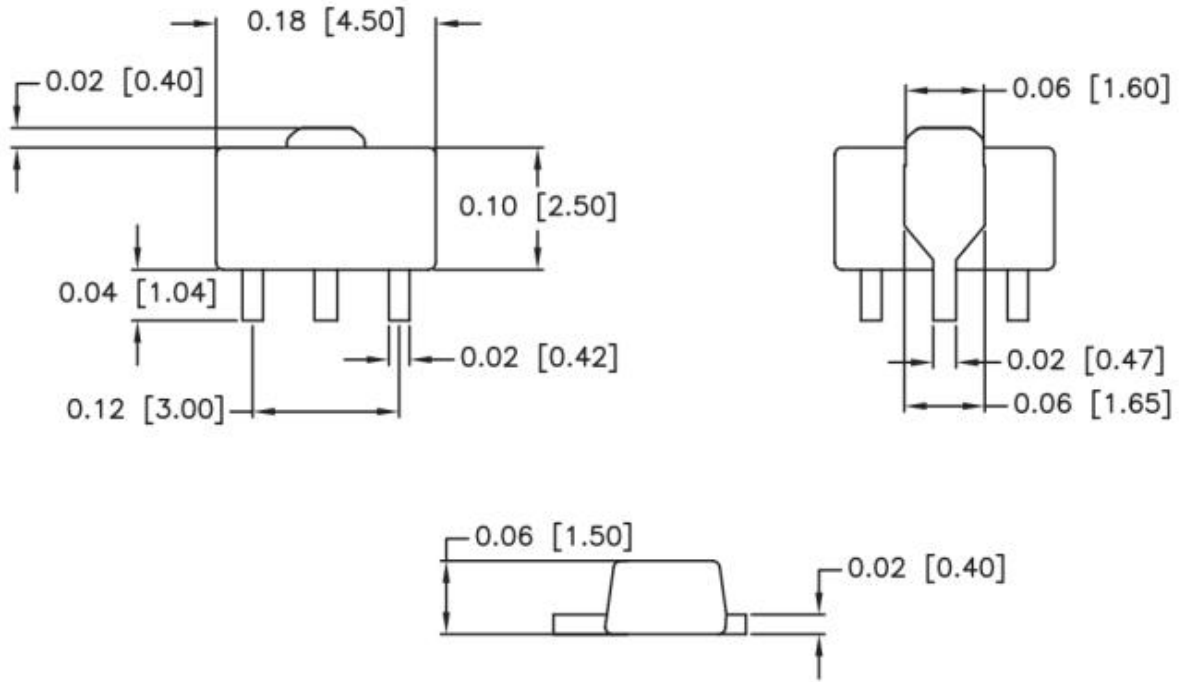
| | | | |
|--------------------------------|-------|------|--------------------|
| Case Operating Temperature | T_c | +150 | $^{\circ}\text{C}$ |
| Operating Junction Temperature | T_j | +225 | $^{\circ}\text{C}$ |

Table4. Electrical Characteristics

| Characteristics | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|---|-----------------|------|-------|------|----------------------|---|
| DC Characteristics | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | | -2.8 | | V | $V_{DS}=28\text{V}, I_D=1.6\text{mA}$ |
| Gate Quiescent Voltage | $V_{GS(Q)}$ | | -2.65 | | V | $V_{DS}=28\text{V}, I_{DS}=50\text{mA}$ |
| Drain-Source Breakdown Voltage | V_{BR} | | 120 | | V | $V_{GS}=-10\text{V}, I_{DS}=1.6\text{mA}$ |
| Total Device Power Dissipation (Derated above 25 $^{\circ}\text{C}$) | P_{diss} | | 7.2 | | W | |
| Thermal Characteristics | | | | | | |
| Thermal Resistance, Junction to Case $T_c=85^{\circ}\text{C}, T_j=200^{\circ}\text{C}, P_{diss}=7.2\text{W}$ | $R_{\theta JC}$ | | 12.6 | | $^{\circ}\text{C/W}$ | |

Packaging Diagram

(SOT-89, Units: millimeters)



PCB Land Pattern